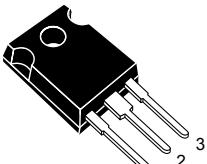
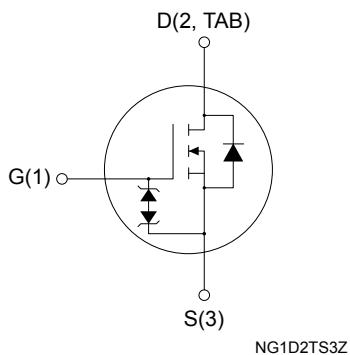


## N-channel 650 V, 93 mΩ typ., 32 A MDmesh DM2 Power MOSFET in a TO-247 package

### Features


**TO-247**


Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STW35N65DM2	650 V	110 mΩ	32 A

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

### Applications

- Switching applications

### Description

This high-voltage N-channel Power MOSFET is part of the MDmesh DM2 fast-recovery diode series. It offers very low recovery charge ( $Q_{rr}$ ) and time ( $t_{rr}$ ) combined with low  $R_{DS(on)}$ , rendering it suitable for the most demanding high-efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.



#### Product status link

[STW35N65DM2](#)

#### Product summary

Order code	STW35N65DM2
Marking	35N65DM2
Package	TO-247
Packing	Tube

## 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage (static)	$\pm 25$	V
	Gate-source voltage (dynamic AC ( $f > 1 \text{ Hz}$ ))	$\pm 30$	
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	32	A
	Drain current (continuous) at $T_C = 100^\circ\text{C}$	20	
$I_{DM}^{(1)}$	Drain current (pulsed)	90	A
$P_{TOT}$	Total power dissipation at $T_C = 25^\circ\text{C}$	250	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	100	V/ns
$di/dt^{(2)}$	Peak diode recovery current slope	1000	A/ $\mu\text{s}$
$dv/dt^{(3)}$	MOSFET dv/dt ruggedness	100	V/ns
$T_{stg}$	Storage temperature	-55 to 150	$^\circ\text{C}$
$T_J$	Operating junction temperature		

1. Pulse width is limited by safe operating area.
2.  $I_{SD} \leq 32 \text{ A}$ ,  $V_{DS} \text{ peak} < V_{(BR)DSS}$ ,  $V_{DD} = 80\% V_{(BR)DSS}$ .
3.  $V_{DS} \leq 520 \text{ V}$ .

**Table 2. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	0.5	$^\circ\text{C/W}$
$R_{thj-amb}$	Thermal resistance junction-ambient	50	$^\circ\text{C/W}$

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}$	Avalanche current, repetitive or not repetitive	4	A
$E_{AS}^{(1)}$	Single pulse avalanche energy	1150	mJ

1. Starting  $T_J = 25^\circ\text{C}$ ,  $I_D = I_{AR}$ ,  $V_{DD} = 50 \text{ V}$ .

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 4. Static**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	650			V
$I_{\text{DSS}}$	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$ <sup>(1)</sup>			100	
$I_{\text{GSS}}$	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			$\pm 5$	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3	4	5	V
$R_{\text{DS(on)}}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$		93	110	$\text{m}\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	2540	-	pF
$C_{oss}$	Output capacitance		-	115	-	pF
$C_{rss}$	Reverse transfer capacitance		-	2.5	-	pF
$C_{oss \text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0 \text{ to } 520 \text{ V}, V_{GS} = 0 \text{ V}$	-	204	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4.2	-	$\Omega$
$Q_g$	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 32 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ (see Figure 14. Test circuit for gate charge behavior)	-	56.3	-	nC
$Q_{gs}$	Gate-source charge		-	12.7	-	nC
$Q_{gd}$	Gate-drain charge		-	27.6	-	nC

1.  $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 16 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform)	-	23.4	-	ns
$t_r$	Rise time		-	23	-	ns
$t_{d(off)}$	Turn-off delay time		-	72	-	ns
$t_f$	Fall time		-	10.4	-	ns

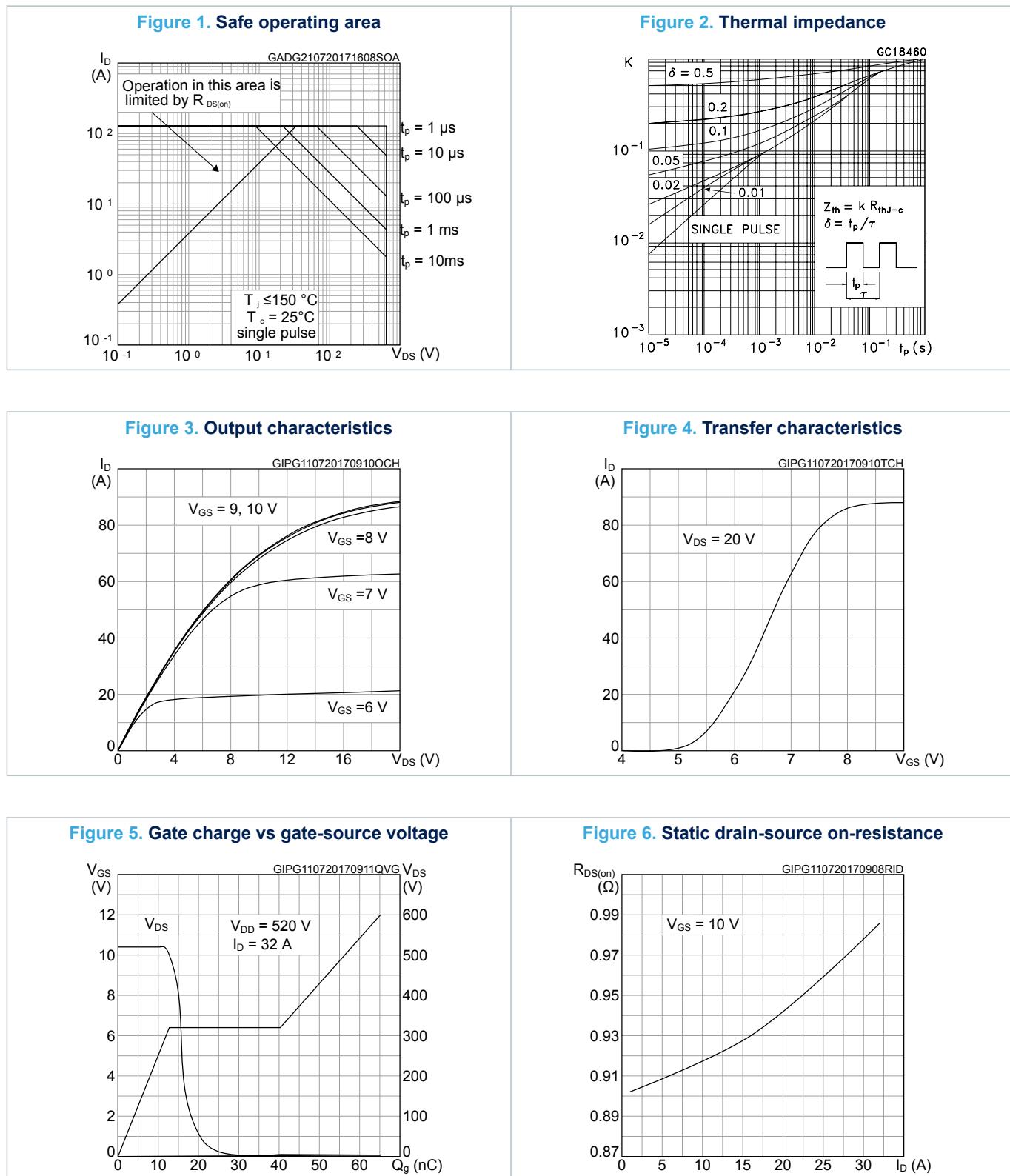
**Table 7. Source-drain diode**

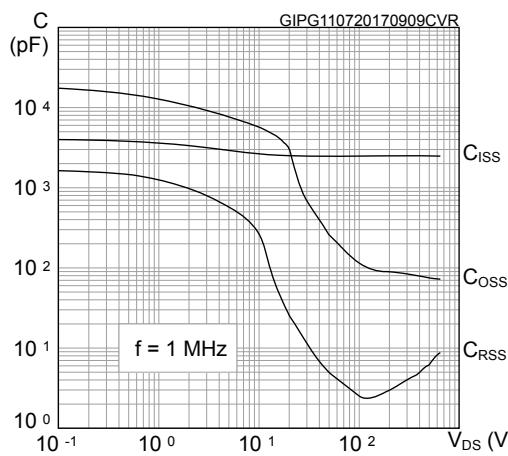
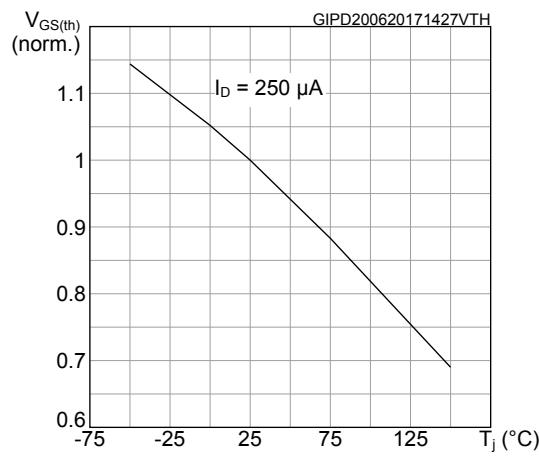
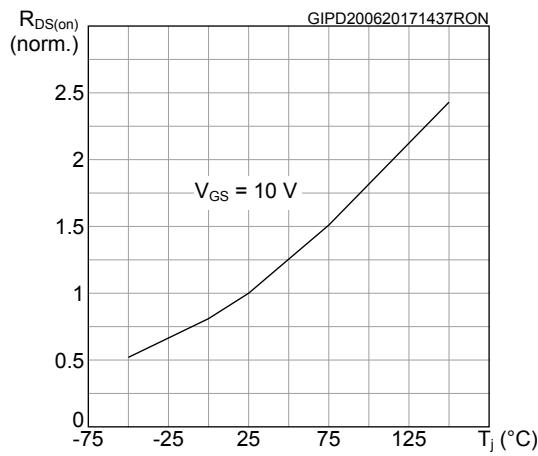
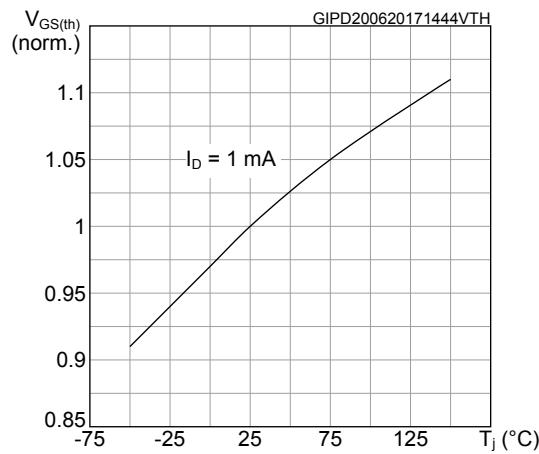
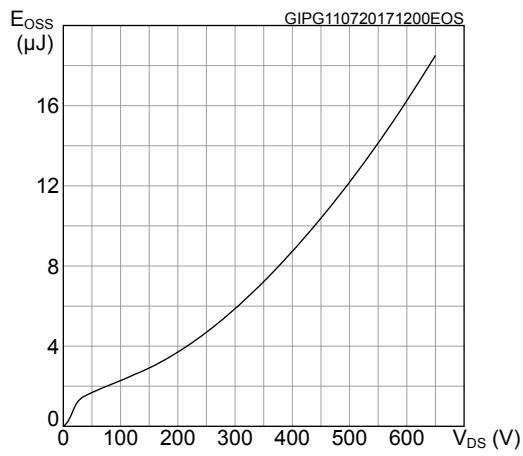
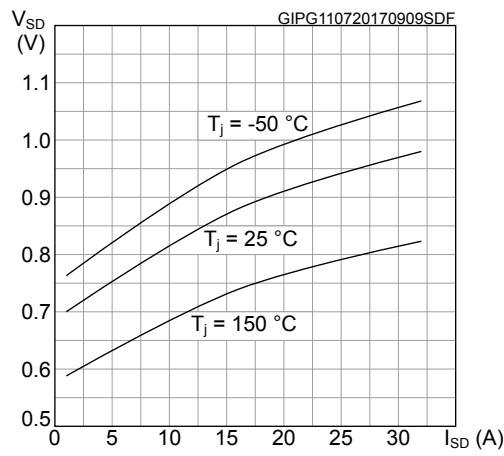
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		32	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		90	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0 \text{ V}$ , $I_{SD} = 32 \text{ A}$	-		1.6	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 32 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ , $V_{DD} = 60 \text{ V}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	100		ns
$Q_{rr}$	Reverse recovery charge		-	0.42		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	8.4		A
$t_{rr}$	Reverse recovery time	$I_{SD} = 32 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$ ,	-	205		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ , $T_J = 150 \text{ }^\circ\text{C}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	1.8		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	17.6		A

1. Pulse width is limited by safe operating area.

2. Pulse test: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

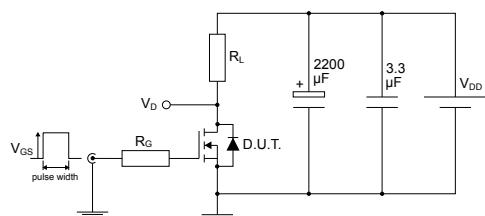
## 2.1 Electrical characteristics (curves)



**Figure 7. Capacitance variations**

**Figure 8. Normalized gate threshold voltage vs temperature**

**Figure 9. Normalized on-resistance vs temperature**

**Figure 10. Normalized V(BR)DSS vs temperature**

**Figure 11. Output capacitance stored energy**

**Figure 12. Source- drain diode forward characteristics**


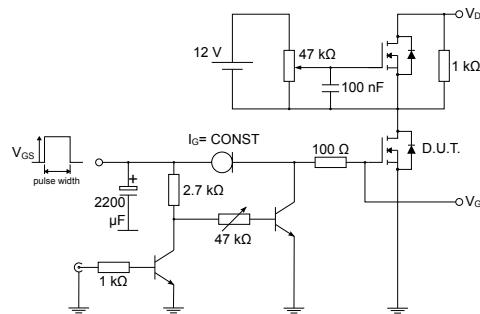
### 3 Test circuits

**Figure 13.** Test circuit for resistive load switching times



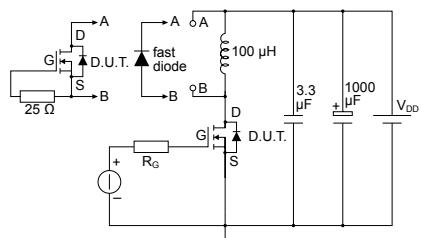
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**Figure 14.** Test circuit for gate charge behavior



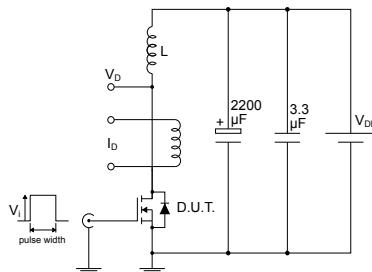
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**Figure 15.** Test circuit for inductive load switching and diode recovery times



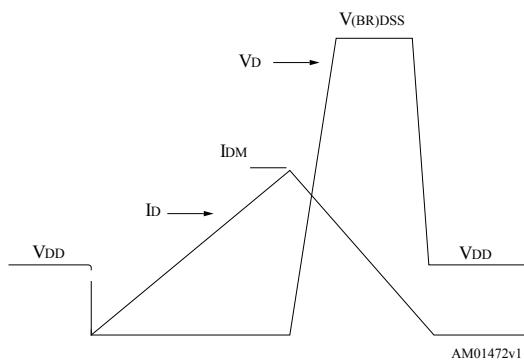
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**Figure 16.** Unclamped inductive load test circuit



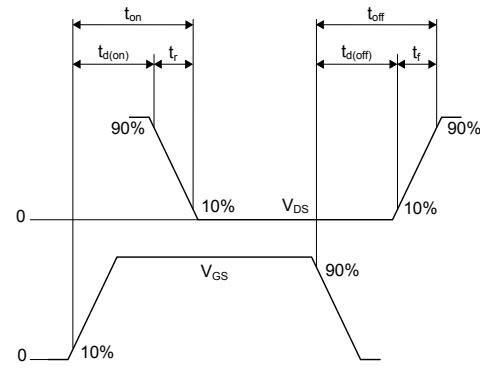
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**Figure 17.** Unclamped inductive waveform



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**Figure 18.** Switching time waveform



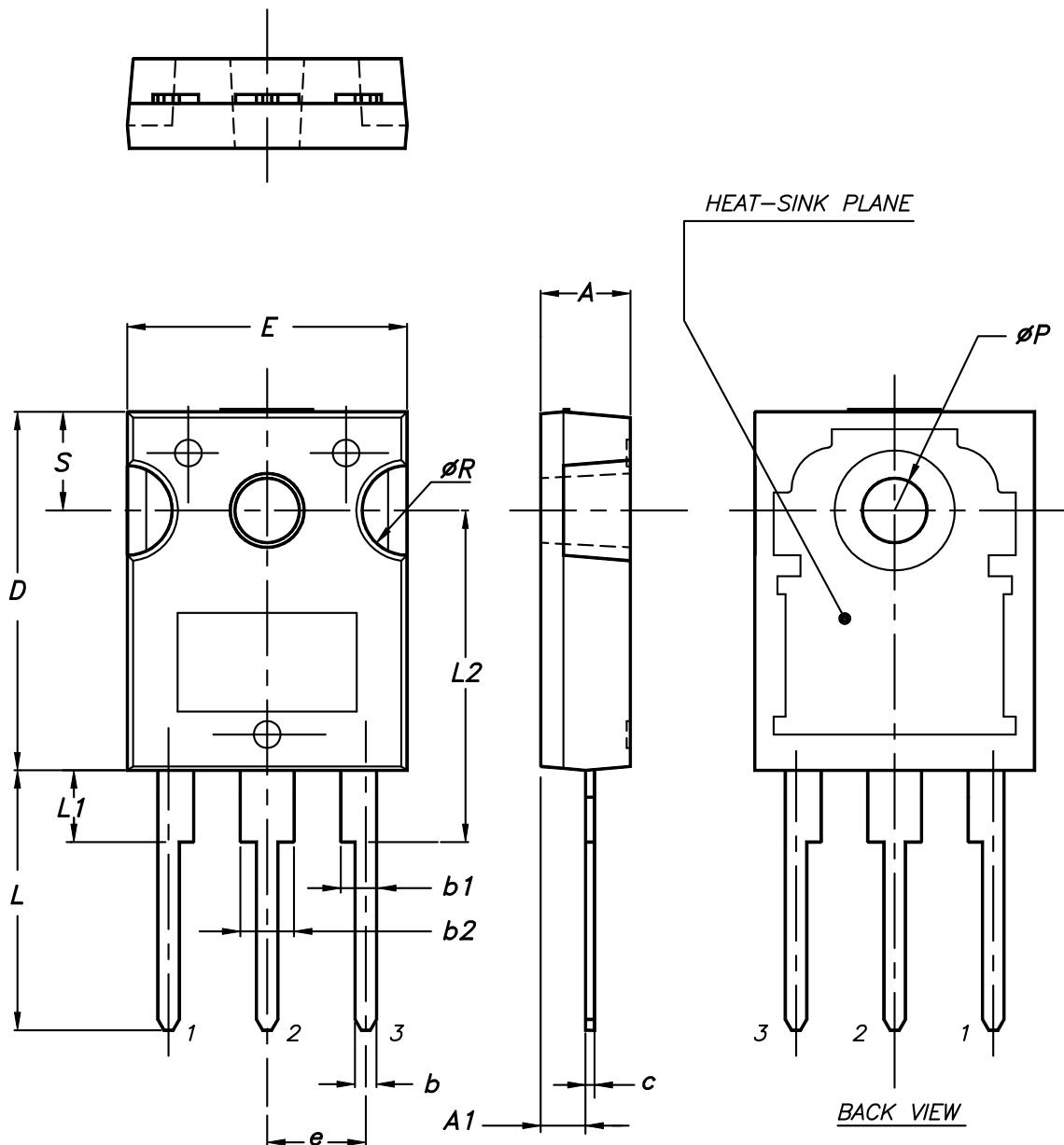
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## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 TO-247 package information

Figure 19. TO-247 package outline



0075325\_9

**Table 8.** TO-247 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

## Revision history

**Table 9. Document revision history**

Date	Revision	Changes
21-Jul-2017	1	Initial release
12-Dec-2017	2	Document status change from preliminary data to production data. Update <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 8: "Source-drain diode"</i> and <i>Figure 2: "Safe operating area"</i> . Minor text changes.
31-Aug-2020	3	Updated <a href="#">Table 1. Absolute maximum ratings</a> . Minor text changes.

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